## **Triple Buffer with Open Drain Outputs**

#### **NL37WZ07**

The NL37WZ07 is a high performance triple buffer with open drain outputs operating from a 1.65 V to 5.5 V supply.

#### **Features**

- Designed for 1.65 V to 5.5 V V<sub>CC</sub> Operation
- 2.1 ns  $t_{PD}$  at  $V_{CC} = 5 \text{ V (Typ)}$
- Inputs/Outputs Overvoltage Tolerant up to 5.5 V
- IOFF Supports Partial Power Down Protection
- Source/Sink 24 mA at 3.0 V
- Available in US8, UDFN8 and UQFN8 Packages
- Chip Complexity < 100 FETs
- –Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

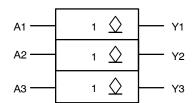
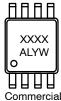


Figure 1. Logic Symbol

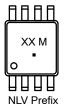
### diagrams <u>∏∏∏</u>



US8 US SUFFIX CASE 493



**MARKING** 





UDFN8, 1.45x1.0 MU3 SUFFIX CASE 517BZ





UDFN8, 1.95x1.0 MU1 SUFFIX CASE 517CA





UQFN8, 1.4x1.2 MQ2 SUFFIX CASE 523AS





UQFN8, 1.6x1.6 MQ1 SUFFIX CASE 523AN



X, XX, XXXX = Specific Device Code
A = Assembly Location
L = Lot Code

Y = Year Code

W = Week Code

M = Date Code

■ Pb-Free Package

#### ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

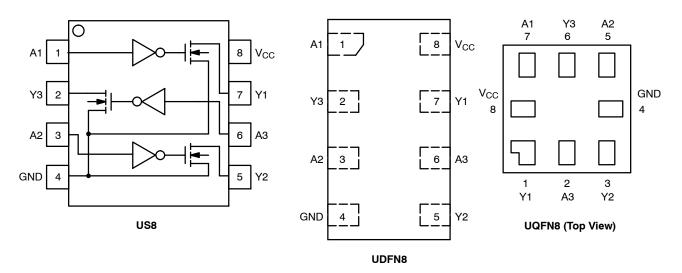


Figure 2. Pinout

#### **PIN ASSIGNMENT**

| Pin | US8 / UDFN8     | UQFN8           |
|-----|-----------------|-----------------|
| 1   | A1              | Y1              |
| 2   | Y3              | A3              |
| 3   | A2              | Y2              |
| 4   | GND             | GND             |
| 5   | Y2              | A2              |
| 6   | А3              | Y3              |
| 7   | Y1              | A1              |
| 8   | V <sub>CC</sub> | V <sub>CC</sub> |

#### **FUNCTION TABLE**

| A Input | Y Output |
|---------|----------|
| L       | L        |
| Н       | Z        |

#### **MAXIMUM RATINGS**

| Symbol                              | Chara                                | Value   | Unit  |      |
|-------------------------------------|--------------------------------------|---|---|------|
| V <sub>CC</sub>                     | DC Supply Voltage                    |   | -0.5 to +6.5  | V    |
| V <sub>IN</sub>                     | DC Input Voltage                     |   | -0.5 to +6.5  | V    |
| V <sub>OUT</sub>                    | DC Output Voltage                    | Active-Mode (High or Low State)<br>Tri-State Mode (Note 1)<br>Power-Down Mode (V <sub>CC</sub> = 0 V) | -0.5 to V <sub>CC</sub> + 0.5<br>-0.5 to +6.5<br>-0.5 to +6.5 | V    |
| I <sub>IK</sub>                     | DC Input Diode Current               | V <sub>IN</sub> < GND   | -50   | mA   |
| I <sub>OK</sub>                     | DC Output Diode Current              | V <sub>OUT</sub> < GND  | -50   | mA   |
| I <sub>OUT</sub>                    | DC Output Source/Sink Current        |   | ±50   | mA   |
| I <sub>CC</sub> or I <sub>GND</sub> | DC Supply Current per Supply Pin or  | Ground Pin  | ±100  | mA   |
| T <sub>STG</sub>                    | Storage Temperature Range            |   | -65 to +150   | °C   |
| $T_L$                               | Lead Temperature, 1 mm from Case for | or 10 secs  | 260   | °C   |
| TJ                                  | Junction Temperature Under Bias      |   | +150  | °C   |
| $\theta_{\sf JA}$                   | Thermal Resistance (Note 2)          | US8<br>UQFN8<br>UDFN8   | 250<br>210<br>231   | °C/W |
| P <sub>D</sub>                      | Power Dissipation in Still Air       | US8<br>UQFN8<br>UDFN8   | 500<br>595<br>541   | mW   |
| MSL                                 | Moisture Sensitivity                 |   | Level 1   | _    |
| F <sub>R</sub>                      | Flammability Rating                  | Oxygen Index: 28 to 34  | UL 94 V-0 @ 0.125 in  | -    |
| V <sub>ESD</sub>                    | ESD Withstand Voltage (Note 3)       | Human Body Model<br>Charged Device Model  | 2000<br>1000  | V    |
| I <sub>Latchup</sub>                | Latchup Performance (Note 4)         |   | ±100  | mA   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Applicable to devices with outputs that may be tri-stated.
- Measured with minimum pad spacing on an FR4 board, using 10mm-by-1inch, 2 ounce copper trace no air flow per JESD51-7.
   HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to EIA/JESD22-C101-F. JEDEC recommends that ESD qualification to EIA/JESD22-A115-A (Machine Model) be discontinued per JEDEC/JEP172A.
- 4. Tested to EIA/JESD78 Class II.

#### RECOMMENDED OPERATING CONDITIONS

| Symbol                          | Characteristics             |   | Min         | Max                           | Unit |
|---------------------------------|-----------------------------|---|-------------|-------------------------------|------|
| V <sub>CC</sub>                 | Positive DC Supply Voltage  |   | 1.65        | 5.5                           | V    |
| V <sub>IN</sub>                 | DC Input Voltage            |   | 0           | 5.5                           | V    |
| V <sub>OUT</sub>                | DC Output Voltage           | Active–Mode (High or Low State) Tri–State Mode (Note 1) Power–Down Mode ( $V_{CC}$ = 0 V)   | 0<br>0<br>0 | V <sub>CC</sub><br>5.5<br>5.5 |      |
| T <sub>A</sub>                  | Operating Temperature Range |   | -55         | +125                          | °C   |
| t <sub>r</sub> , t <sub>f</sub> | Input Rise and Fall Time    | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | 0<br>0<br>0 | 20<br>20<br>10<br>5           | ns/V |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### DC ELECTRICAL CHARACTERISTICS

|                  |                                   |   | V <sub>CC</sub>  | Т                      | A = 25°  | С  | –55°C ≤ T              | <sub>A</sub> ≤ 125°C                             |       |
|------------------|-----------------------------------|---|--|------------------------|--|--|------------------------|--|-------|
| Symbol           | Parameter                         | Condition   | (V)  | Min                    | Тур  | Max  | Min                    | Max  | Units |
| V <sub>IH</sub>  | High-Level Input                  |   | 1.65 to 1.95   | 0.65 x V <sub>CC</sub> | _  | _  | 0.65 x V <sub>CC</sub> | _  | V     |
|                  | Voltage                           |   | 2.3 to 5.5   | 0.70 x V <sub>CC</sub> | _  | _  | 0.70 x V <sub>CC</sub> | -  |       |
| V <sub>IL</sub>  | Low-Level Input                   |   | 1.65 to 1.95   | -                      | _  | 0.35 x V <sub>CC</sub>                           | -                      | 0.35 x V <sub>CC</sub>                           | V     |
|                  | Voltage                           |   | 2.3 to 5.5   | -                      | _  | 0.30 x V <sub>CC</sub>                           | -                      | 0.30 x V <sub>CC</sub>                           |       |
| V <sub>OL</sub>  | Low-Level Output<br>Voltage       | $\begin{split} &V_{IN} = V_{IH} \text{ or } V_{IL} \\ &I_{OL} = 100  \mu\text{A} \\ &I_{OL} = 4 \text{ mA} \\ &I_{OL} = 8 \text{ mA} \\ &I_{OL} = 12 \text{ mA} \\ &I_{OL} = 16 \text{ mA} \\ &I_{OL} = 24 \text{ mA} \\ &I_{OL} = 32 \text{ mA} \end{split}$ | 1.65 to 5.5<br>1.65<br>2.3<br>2.7<br>3.0<br>3.0<br>4.5 | -<br>-<br>-<br>-<br>-  | -<br>0.08<br>0.2<br>0.22<br>0.28<br>0.38<br>0.42 | 0.1<br>0.24<br>0.3<br>0.4<br>0.4<br>0.55<br>0.55 | -<br>-<br>-<br>-       | 0.1<br>0.24<br>0.3<br>0.4<br>0.4<br>0.55<br>0.55 | V     |
| I <sub>IN</sub>  | Input Leakage<br>Current          | V <sub>IN</sub> = 5.5 V or GND  | 1.65 to 5.5  | -                      | _  | ±0.1   | -                      | ±1.0   | μΑ    |
| I <sub>OZ</sub>  | 3-State Output<br>Leakage Current | V <sub>OUT</sub> = 0 V to 5.5 V   | 1.65 to 5.5  | -                      | -  | ±0.5   | -                      | ±5.0   | μΑ    |
| I <sub>OFF</sub> | Power Off Leakage<br>Current      | V <sub>IN</sub> = 5.5 V or<br>V <sub>OUT</sub> = 5.5 V  | 0  | -                      | _  | 1.0  | -                      | 10   | μΑ    |
| I <sub>CC</sub>  | Quiescent Supply<br>Current       | $V_{IN} = V_{CC}$ or GND  | 5.5  | -                      | -  | 1.0  | -                      | 10   | μΑ    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

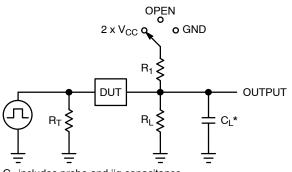
#### **AC ELECTRICAL CHARACTERISTICS**

|                  |  | V <sub>CC</sub> T <sub>A</sub> = 25°C |              | С   | -55°C ≤ T <sub>A</sub> ≤ 125°C |     |     |     |       |
|------------------|--|---------------------------------------|--------------|-----|--------------------------------|-----|-----|-----|-------|
| Symbol           | Parameter  | Condition                             | (V)          | Min | Тур                            | Max | Min | Max | Units |
| t <sub>PZL</sub> | Propagation Delay, A to Y                                    |                                       | 1.65 to 1.95 | _   | 6.0                            | 9.0 | -   | 9.5 | ns    |
|                  | (Figures 3 and 4)  | d 4)                                  | 2.3 to 2.7   | -   | 3.6                            | 6.1 | -   | 6.5 |       |
|                  |  |                                       | 3.0 to 3.6   | -   | 2.7                            | 5.6 | -   | 6.0 |       |
|                  |  |                                       | 4.5 to 5.5   | -   | 2.1                            | 4.4 | -   | 4.8 |       |
| t <sub>PLZ</sub> | t <sub>PLZ</sub> Propagation Delay, A to Y (Figures 3 and 4) | 1.65 to 1.95                          | _            | 4.0 | 9.0                            | -   | 9.5 | ns  |       |
|                  |  | (Figures 3 and 4)                     | 2.3 to 2.7   | _   | 2.8                            | 6.1 | -   | 6.5 |       |
|                  |  |                                       | 3.0 to 3.6   | _   | 2.5                            | 5.6 | -   | 6.0 |       |
|                  |  |                                       | 4.5 to 5.5   |     | 2.2                            | 4.4 | -   | 4.8 |       |

#### **CAPACITIVE CHARACTERISTICS**

| Symbol           | Parameter                              | Condition   | Typical | Units |
|------------------|--|---|---------|-------|
| C <sub>IN</sub>  | Input Capacitance                      | $V_{CC} = 5.5 \text{ V}, V_{IN} = 0 \text{ V or } V_{CC}$   | 2.5     | pF    |
| C <sub>OUT</sub> | Output Capacitance                     | $V_{CC} = 5.5 \text{ V}, V_{IN} = 0 \text{ V or } V_{CC}$   | 2.5     | pF    |
| C <sub>PD</sub>  | Power Dissipation Capacitance (Note 5) | 10 MHz, $V_{CC}$ = 3.3 V, $V_{IN}$ = 0 V or $V_{CC}$ 10 MHz, $V_{CC}$ = 5.5 V, $V_{IN}$ = 0 V or $V_{CC}$ | 9<br>11 | pF    |

C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>in</sub> + I<sub>CC</sub>. C<sub>PD</sub> is used to determine the no–load dynamic power consumption; P<sub>D</sub> = C<sub>PD</sub> • V<sub>CC</sub><sup>2</sup> • f<sub>in</sub> + I<sub>CC</sub> • V<sub>CC</sub>.



| Test                                | Switch<br>Position  | C <sub>L</sub> , pF          | $R_L, \Omega$ | <b>R</b> <sub>1</sub> , Ω |
|-------------------------------------|---------------------|------------------------------|---------------|---------------------------|
| t <sub>PLH</sub> / t <sub>PHL</sub> | Open                | See AC Characteristics Table |               |                           |
| t <sub>PLZ</sub> / t <sub>PZL</sub> | 2 x V <sub>CC</sub> | 50                           | 500           | 500                       |
| t <sub>PHZ</sub> / t <sub>PZH</sub> | GND                 | 50                           | 500           | 500                       |

X = Don't Care

C<sub>L</sub> includes probe and jig capacitance  $R_T$  is  $Z_{OUT}$  of pulse generator (typically 50  $\Omega$ ) f=1 MHz

Figure 3. Test Circuit

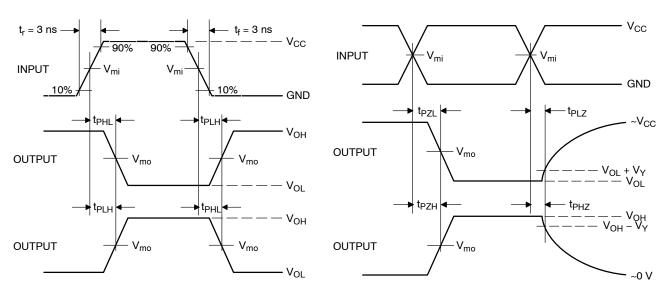


Figure 4. Switching Waveforms

|                     |                     | V <sub>m</sub>                      |   |                    |
|---------------------|---------------------|-------------------------------------|---|--------------------|
| V <sub>CC</sub> , V | V <sub>mi</sub> , V | t <sub>PLH</sub> , t <sub>PHL</sub> | t <sub>PZL</sub> , t <sub>PLZ</sub> , t <sub>PZH</sub> , t <sub>PHZ</sub> | V <sub>Y</sub> , V |
| 1.65 to 1.95        | V <sub>CC</sub> /2  | V <sub>CC</sub> /2                  | V <sub>CC</sub> /2  | 0.15               |
| 2.3 to 2.7          | V <sub>CC</sub> /2  | V <sub>CC</sub> /2                  | V <sub>CC</sub> /2  | 0.15               |
| 3.0 to 3.6          | V <sub>CC</sub> /2  | V <sub>CC</sub> /2                  | V <sub>CC</sub> /2  | 0.3                |
| 4.5 to 5.5          | V <sub>CC</sub> /2  | V <sub>CC</sub> /2                  | V <sub>CC</sub> /2  | 0.3                |

#### **DEVICE ORDERING INFORMATION**

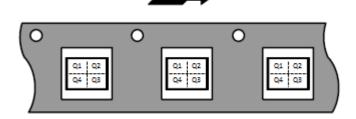
| Device  | Packages                 | Specific Device Code | Pin 1 Orientation<br>(See below) | Shipping <sup>†</sup> |
|---|--------------------------|----------------------|----------------------------------|-----------------------|
| NL37WZ07USG                                       | US8                      | L7                   | Q4                               | 3000 / Tape & Reel    |
| NL37WZ07USG-Q*<br>(Please contact <b>onsemi</b> ) | US8                      | L7                   | Q4                               | 3000 / Tape & Reel    |
| NL37WZ07MQ1TCG<br>(Please contact <b>onsemi</b> ) | UQFN8, 1.6 x 1.6, 0.5P   | TBD                  | TBD                              | 3000 / Tape & Reel    |
| NL37WZ07MU1TCG<br>(Please contact <b>onsemi</b> ) | UDFN8, 1.95 x 1.0, 0.5P  | TBD                  | TBD                              | 3000 / Tape & Reel    |
| NL37WZ07MU3TCG<br>(Please contact <b>onsemi</b> ) | UDFN8, 1.45 x 1.0, 0.35P | TBD                  | TBD                              | 3000 / Tape & Reel    |
| NL37WZ07MQ2TCG<br>(Please contact <b>onsemi</b> ) | UQFN8, 1.4 x 1.2, 0.4P   | TBD                  | TBD                              | 3000 / Tape & Reel    |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP

#### Pin 1 Orientation in Tape and Reel

#### Direction of Feed

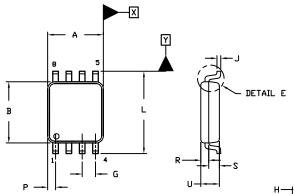


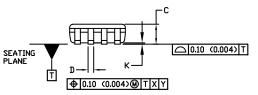
Capable.

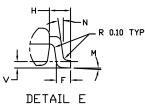
#### **PACKAGE DIMENSIONS**

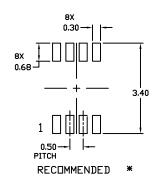
#### US8 **CASE 493**

# ISSUE F









MOUNTING FOOTPRINT

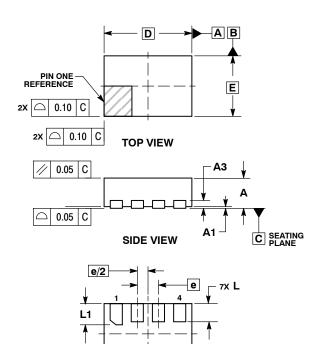
#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSION, OR GATE BURR. MOLD FLASH, PROTRUSION, OR GATE BURR SHALL NOT EXCEED 0.14 (0.0055°) PER SIDE.
- 4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH AND PROTRUSION SHALL NOT EXCEED 0.14 (0.0055") PER SIDE.
- LEAD FINISH IS SOLDER PLATING WITH THICKNESS OF 0.0076-0.0203 MM (0.003-0.008").
- ALL TOLERANCE UNLESS OTHERWISE SPECIFIED ±0.0508 MM (0.002").

|     | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
| DIM | MIN.        | MAX. | MIN.      | MAX.  |
| Α   | 1.90        | 2.10 | 0.075     | 0.083 |
| В   | 2.20        | 2.40 | 0.087     | 0.094 |
| С   | 0.60        | 0.90 | 0.024     | 0.035 |
| D   | 0.17        | 0.25 | 0.007     | 0.010 |
| F   | 0.20        | 0.35 | 0.008     | 0.014 |
| G   | 0.50        | BSC  | 0.020     | BSC   |
| Н   | 0.40        | REF  | 0.016 REF |       |
| J   | 0.10        | 0.18 | 0.004     | 0.007 |
| К   | 0.00        | 0.10 | 0.000     | 0.004 |
| L   | 3.00        | 3.25 | 0.118     | 0.128 |
| М   | 0*          | 6*   | 0*        | 6°    |
| N   | 0*          | 10*  | 0*        | 10*   |
| Р   | 0.23        | 0.34 | 0.010     | 0.013 |
| R   | 0.23        | 0.33 | 0.009     | 0.013 |
| S   | 0.37        | 0.47 | 0.015     | 0.019 |
| U   | 0.60        | 0.80 | 0.024     | 0.031 |
|     | 0.12 BSC    |      | 0.005     | BSC   |

#### **PACKAGE DIMENSIONS**

UDFN8, 1.45x1.0, 0.35P CASE 517BZ ISSUE O



**BOTTOM VIEW** 

8x b

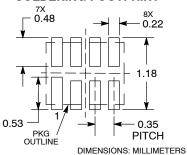
0.10 M C A B

0.05 M C NOTE 3

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
  3. DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 MM FROM TERMINAL TIP.
  4. PACKAGE DIMENSIONS EXCLUSIVE OF BURRS AND MOLD FLASH.

|     | MILLIMETERS |      |  |  |
|-----|-------------|------|--|--|
| DIM | MIN         | MAX  |  |  |
| Α   | 0.45        | 0.55 |  |  |
| A1  | 0.00        | 0.05 |  |  |
| A3  | 0.13 REF    |      |  |  |
| b   | 0.15        | 0.25 |  |  |
| D   | 1.45        | BSC  |  |  |
| E   | 1.00        | BSC  |  |  |
| е   | 0.35 BSC    |      |  |  |
| L   | 0.25        | 0.35 |  |  |
| L1  | 0.30        | 0.40 |  |  |

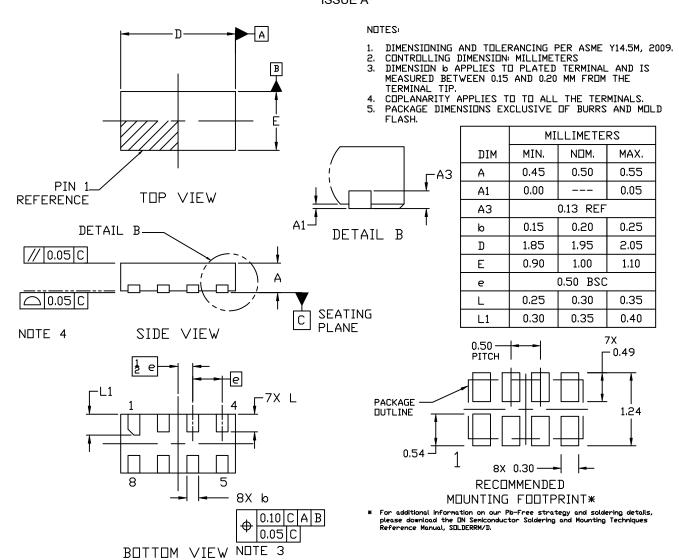
#### **RECOMMENDED SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

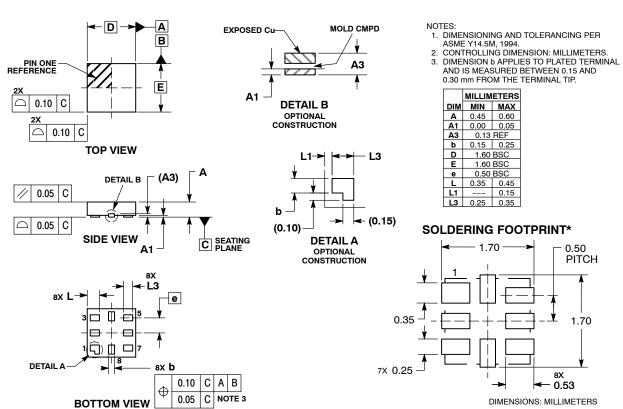
#### **PACKAGE DIMENSIONS**

### **UDFN8, 1.95x1.0, 0.5P**CASE 517CA ISSUE A



#### **PACKAGE DIMENSIONS**

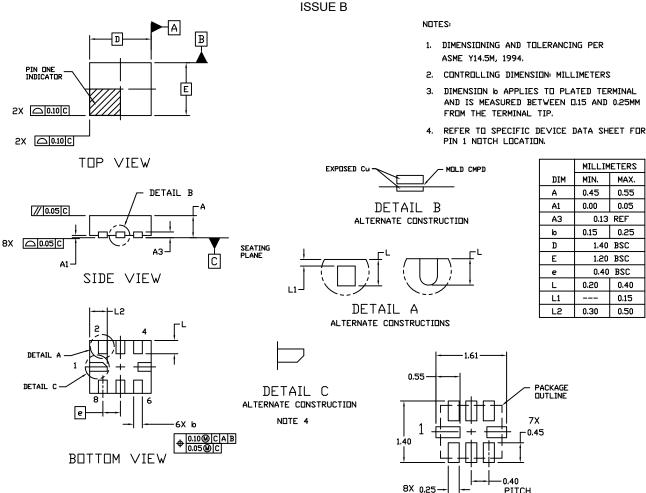
#### UQFN8, 1.6x1.6, 0.5P CASE 523AN ISSUE O



\*For additional information on our Pb–Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### PACKAGE DIMENSIONS

#### UQFN8, 1.40x1.20, 0.40P CASE 523AS



For additional information on our Pb-Free strategy and soldering details, please download the  $\Box N$  Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

RECOMMENDED MOUNTING FOOTPRINT \*

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